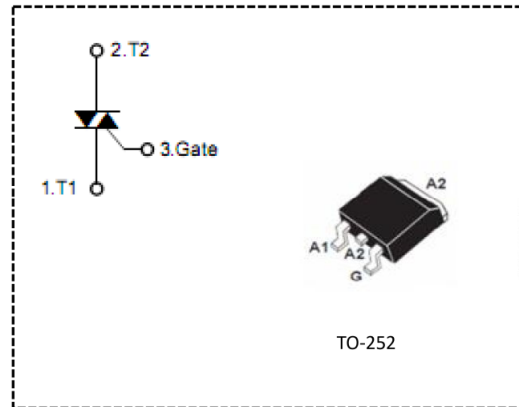


◆ 用途

主要用于调光、调温等调压电路，微波炉、洗衣机、电风扇、饮水机、夜明灯等家电的控制电路及用于交流相控、斩波器、逆变器、变频器和固态继电器等电路中

◆ 特征

采用先进的玻璃钝化工艺，较低的通态压降，高的可靠性、稳定性



◆ 极限值

名称	符号	规范值	单位	测试条件
重复峰值阻断电压	V_{DRM}	600/800	V	$I_{DRM}=20\mu A$
通态电流	$I_{T(RMS)}$	4	A	正弦波 180°
浪涌电流	I_{TSM}	45	A	正弦波,60Hz
结温	T_j	125	°C	
贮存温度	T_{stg}	-40~150	°C	

◆ 电特性

名称	符号	测试条件	Min	Max	单位	
通态电压	V_{TM}	$I_T=10A$	----	1.65	V	
维持电流	I	$V_D=12V, I_{GT}=100mA$	----	40	mA	
	II		----	40		
门极触发电流	I	T2(+),G(+)	$V_D=12V, R_L=100\Omega$	----	50	mA
	II	T2(+),G(-)		----	50	
	III	T2(-),G(-)		----	50	
	IV	T2(-),G(+)		----	----	
门极触发电压	I	T2(+),G(+)	$V_D=12V, R_L=100\Omega$	----	2	V
	II	T2(+),G(-)		----	2	
	III	T2(-),G(-)		----	2	
	IV	T2(-),G(+)		----	----	
断态电压临界上升率	dV/dt	$V_D=0.66 \times V_{DRM}$ $T_J=125^\circ C$ Exponential waveform, Gate open	500		V/ μs	
通态电流临界上升率	dI/dt	$T_J=125^\circ C, f=120Hz, I_G=2 \times I_{GT}, tr \le 120ns$		50	A/ μs	
断态电流临界上升率	dI/dt©	$V_{DM}=400V$ $T_J=125^\circ C$ $I_{T(RMS)}=4A$ dV/dt=0.1V/ μs Gate open	5		A/ms	
热阻	$R_{th(j-c)}$	结到外壳		2.0	°C/W	
	$R_{th(j-a)}$	结到环境		70		

◆ 产品包装

封装形式	数量	包装材质
TO-252	2500/盘、25000/箱	盘/箱

◆ 特性数据

Figure 1. Maximum power dissipation versus rms on-state current (full cycle)

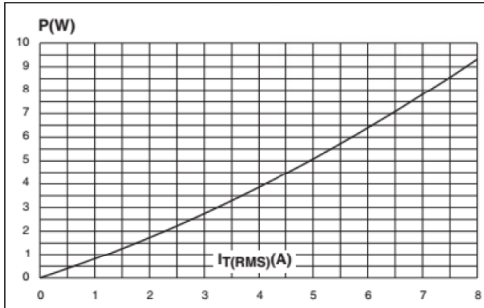


Figure 2. On-state rms current versus case temperature (full cycle)

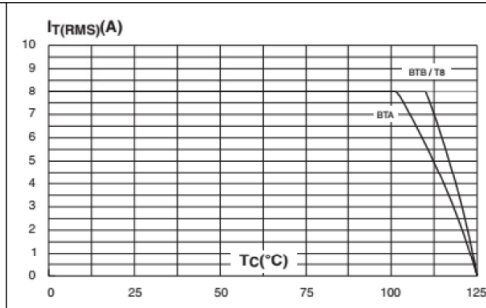


Figure 3. On-state rms current versus ambient temperature (full cycle)

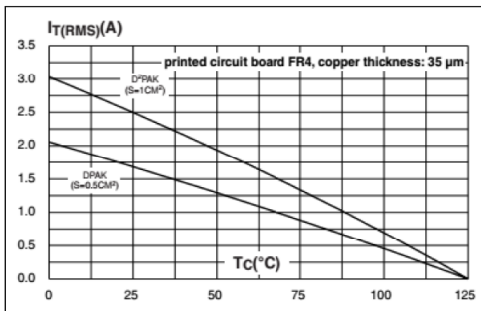


Figure 4. Relative variation of thermal impedance versus pulse duration

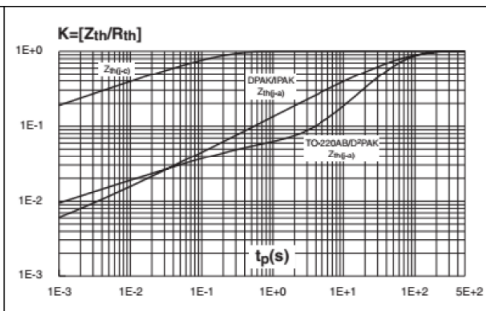


Figure 5. On-state characteristics (maximum values)

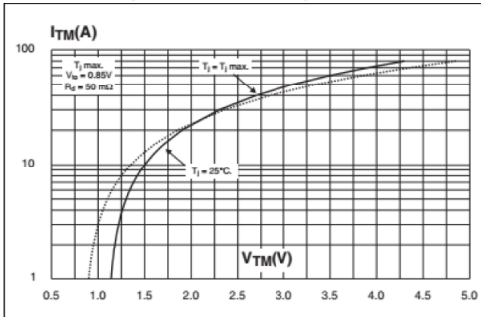


Figure 6. Surge peak on-state current versus number of cycles

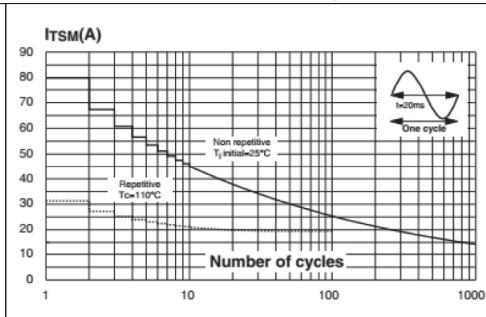


Figure 7. Non-repetitive surge peak on-state current for a sinusoidal

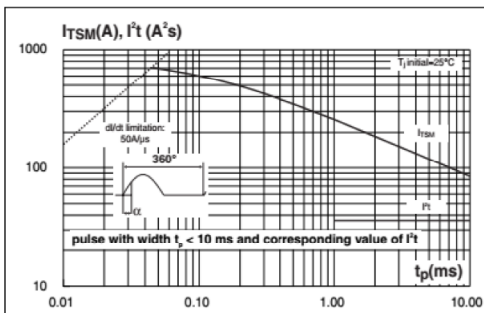


Figure 8. Relative variation of gate trigger current

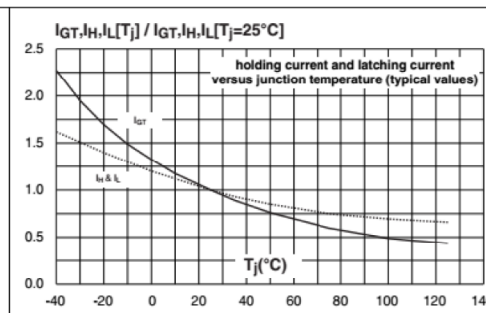


Figure 9. Relative variation of critical rate of decrease of main current versus $(dV/dt)_c$ (typical values)

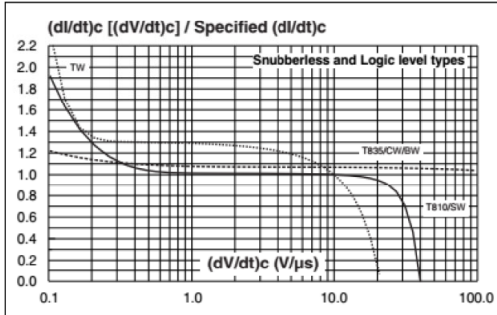


Figure 10. Relative variation of critical rate of decrease of main current versus $(dV/dt)_c$ (typical values)

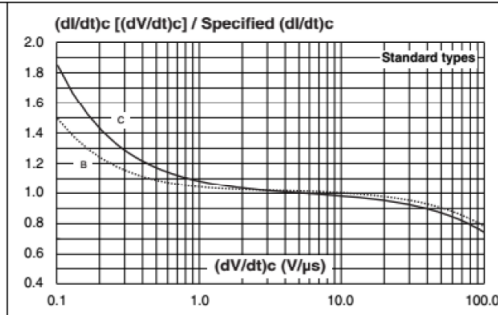


Figure 11. Relative variation of critical rate of decrease of main current versus junction temperature

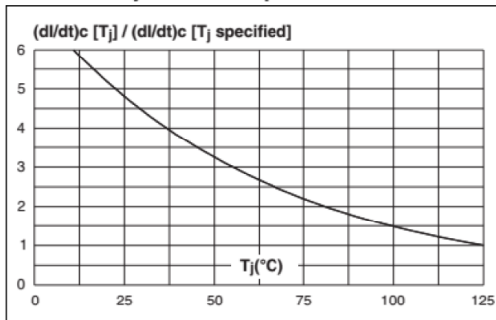
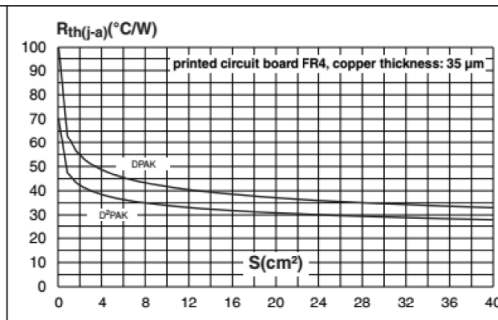
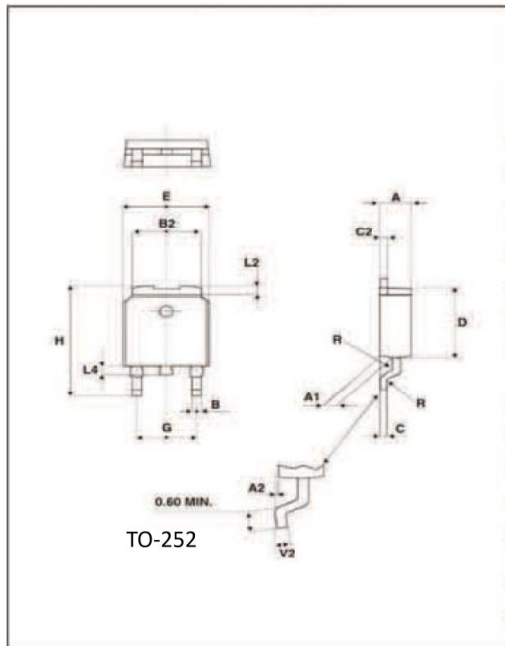


Figure 12. DPAK and D²PAK thermal resistance junction to ambient versus copper surface under tab



◆ 产品尺寸



Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	2.20	2.40	0.086	0.094
A1	0.90	1.10	0.035	0.043
A2	0.03	0.23	0.001	0.009
B	0.64	0.90	0.025	0.035
B2	5.20	5.40	0.204	0.212
C	0.45	0.60	0.017	0.023
C2	0.48	0.60	0.018	0.023
D	6.00	6.20	0.236	0.244
E	6.40	6.60	0.251	0.259
G	4.40	4.60	0.173	0.181
H	9.35	10.10	0.368	0.397
L2	0.80 typ.		0.031 typ.	
L4	0.60	1.00	0.023	0.039
V2	0°	8°	0°	8°

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